

L Number	Hits	Search Text	DB	Time stamp
1	1516	("604.525").PN. or (("600/585") or ("600/114") or ("600/434") or ("604/170.01") or ("604/107.03") or ("604/526")).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/20 13:17
2	1207	((("604.525").PN. or (("600/585") or ("600/114") or ("600/434") or ("604/170.01") or ("604/107.03") or ("604/526")).CCLS.) and guide\$	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/20 13:17
3	576	((("604.525").PN. or (("600/585") or ("600/114") or ("600/434") or ("604/170.01") or ("604/107.03") or ("604/526")).CCLS.) and guide\$) and guidewire\$	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/20 13:18
4	257	(((((("604.525").PN. or (("600/585") or ("600/114") or ("600/434") or ("604/170.01") or ("604/107.03") or ("604/526")).CCLS.) and guide\$) and guidewire\$) and alloys	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/20 13:18
-	1610	((("600/585") or ("600/114") or ("600/434") or ("604/170.01") or ("604/107.03") or ("604/525") or ("604/526")).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/20 11:46
-	0	((("600/585") or ("600/114") or ("600/434") or ("604/170.01") or ("604/107.03") or ("604/525") or ("604/526")).CCLS.) and BioDur	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/20 11:46
-	2	biodur	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/20 11:46
-	47	biodur\$	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/20 11:46
-	1	biodur\$ and guidewire\$	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/20 11:50
-	606	((("600/585") or ("600/114") or ("600/434") or ("604/170.01") or ("604/107.03") or ("604/525") or ("604/526")).CCLS.) and guidewire\$	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/20 11:51

Class	Code	Text	IPC Class	US Patent	US Patent
4	(((600/585 600/114 600/434 604/170.01 604/107 604/525 602/026).C2A.S.))	and guidewire\$) and (nickel xor Ni xor NiTi xor nitinol xor Ni-Ti) ) and heat-treat\$	US-PGPUB; EPO; JPO; DERWENT; IBM TDB	11:58	
3	(alloy not (nickel or Ni or NiTi or nitinol or Ni-Ti)) and (guidewire same heat-treat\$)		USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/20 12:22	
0	(percent near5 (nickel or Ni)) and (guidewire same heat-treat\$)		USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/20 12:08	
32	(percent near5 (nickel or Ni)) and guidewire		USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/20 12:38	
9	((guidewire or obturator or stylet) same (alloy not (nickel or Ni or NiTi or nitinol))) and (heat near3 treat\$)		USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/20 12:26	
0	(guidewire or obturator or stylet) same (alloy same ((trace or minimal or negligible or small) near5 (nickel or Ni or NiTi or nitinol))) and (heat near3 treat\$)		USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/20 12:30	
33	(guidewire or obturator or stylet) and (alloy same ((trace or minimal or negligible or small) near5 (nickel or Ni or NiTi or nitinol)))		USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/20 12:31	
2	((percent near5 composition) near5 (nickel or Ni)) and guidewire		USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/20 12:42	
19	((percent near5 composition) same (nickel or Ni)) and guidewire		USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/11/20 12:43	